



JMSH1509AG

150V 8.5mΩ N-Ch Power MOSFET

Features

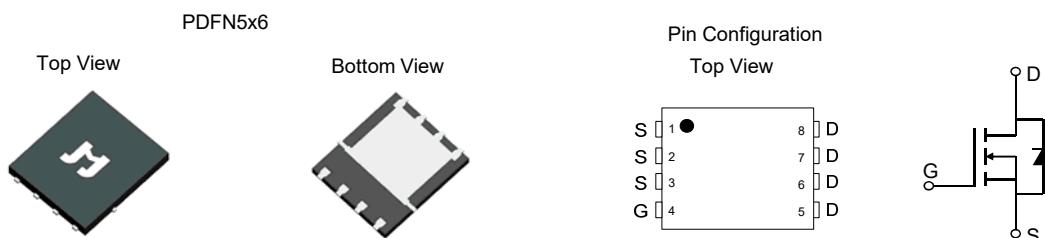
- Ultra-low $R_{DS(ON)}$
- Low Gate Charge
- High Current Capability
- 100% UIS Tested, 100% R_g Tested

Product Summary

| Parameter | Typ. | Unit |
|---------------------------------------|------|------|
| V_{DS} | 150 | V |
| $V_{GS(th)}$ | 3.0 | V |
| $I_D (@ V_{GS} = 10V)$ ⁽¹⁾ | 75 | A |
| $R_{DS(ON)} (@ V_{GS} = 10V)$ | 8.5 | mΩ |

Applications

- Power Management in Telecom., Industrial Automation, CE
- Current Switching in DC/DC & AC/DC (SR) Sub-systems
- Motor Driving in Power Tool, E-vehicle, Robotics

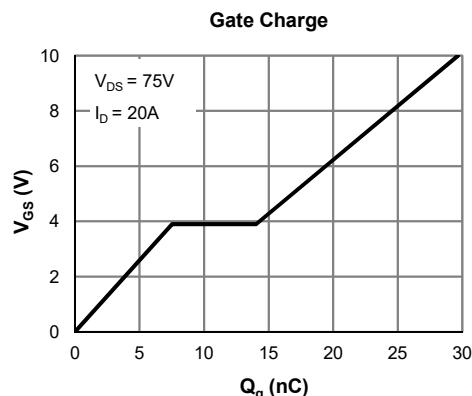
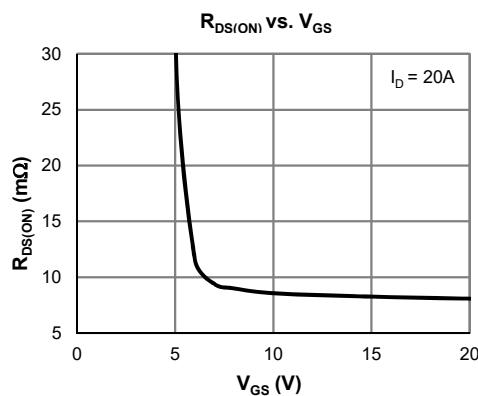


Ordering Information

| Device | Package | # of Pins | Marking | MSL | T_J (°C) | Media | Quantity (pcs) |
|---------------|---------|-----------|---------|-----|------------|--------------|----------------|
| JMSH1509AG-13 | PDFN5x6 | 8 | SH1509A | 1 | -55 to 150 | 13-inch Reel | 3000 |

Absolute Maximum Ratings (@ $T_A = 25^\circ\text{C}$ unless otherwise specified)

| Parameter | Symbol | Value | Unit |
|--|----------------|------------|------|
| Drain-to-Source Voltage | V_{DS} | 150 | V |
| Gate-to-Source Voltage | V_{GS} | ± 20 | V |
| Continuous Drain Current ($T_C = 25^\circ\text{C}$) | I_D | 75 | A |
| | | 60 | |
| Pulsed Drain Current ⁽²⁾ | I_{DM} | 270 | A |
| Avalanche Current ⁽³⁾ | I_{AS} | 68 | A |
| Avalanche Energy ⁽³⁾ | E_{AS} | 231 | mJ |
| Power Dissipation ⁽⁴⁾ ($T_C = 25^\circ\text{C}$) | P_D | 125 | W |
| | | 50 | |
| Junction & Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |



**Electrical Characteristics (@ $T_J = 25^\circ\text{C}$ unless otherwise specified)**

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|---|-----------------------------|--|------|------|-----------|------------------|
| STATIC PARAMETERS | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$ | 150 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 120\text{V}, V_{GS} = 0\text{V}$ $T_J = 55^\circ\text{C}$ | | | 1.0 | μA |
| | | | | | 5.0 | |
| Gate-Body Leakage Current | I_{GSS} | $V_{DS} = 0\text{V}, V_{GS} = \pm 20\text{V}$ | | | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(\text{th})}$ | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ | 2.0 | 3.0 | 4.0 | V |
| Static Drain-Source ON-Resistance | $R_{DS(\text{ON})}$ | $V_{GS} = 10\text{V}, I_D = 20\text{A}$ | | 8.5 | 9.9 | $\text{m}\Omega$ |
| Forward Transconductance | g_{FS} | $V_{DS} = 5\text{V}, I_D = 20\text{A}$ | | 60 | | S |
| Diode Forward Voltage | V_{SD} | $I_S = 1\text{A}, V_{GS} = 0\text{V}$ | | 0.71 | 1.0 | V |
| Diode Continuous Current | I_S | $T_C = 25^\circ\text{C}$ | | | 125 | A |
| DYNAMIC PARAMETERS⁽⁵⁾ | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0\text{V}, V_{DS} = 75\text{V}, f = 1\text{MHz}$ | | 2181 | | pF |
| Output Capacitance | C_{oss} | | | 363 | | pF |
| Reverse Transfer Capacitance | C_{rss} | | | 7.9 | | pF |
| Gate Resistance | R_g | $V_{GS} = 0\text{V}, V_{DS} = 0\text{V}, f = 1\text{MHz}$ | | 2.5 | | Ω |
| SWITCHING PARAMETERS⁽⁵⁾ | | | | | | |
| Total Gate Charge (@ $V_{GS} = 10\text{V}$) | Q_g | $V_{GS} = 0$ to 10V $V_{DS} = 75\text{V}, I_D = 20\text{A}$ | | 30 | | nC |
| Total Gate Charge (@ $V_{GS} = 4.5\text{V}$) | Q_g | | | 19.4 | | nC |
| Gate Source Charge | Q_{gs} | | | 7.5 | | nC |
| Gate Drain Charge | Q_{gd} | | | 6.5 | | nC |
| Turn-On Delay Time | $t_{D(on)}$ | $V_{GS} = 10\text{V}, V_{DS} = 75\text{V}$ $R_L = 3.75\Omega, R_{\text{GEN}} = 6\Omega$ | | 12.5 | | ns |
| Turn-On Rise Time | t_r | | | 24 | | ns |
| Turn-Off Delay Time | $t_{D(off)}$ | | | 30 | | ns |
| Turn-Off Fall Time | t_f | | | 26 | | ns |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F = 20\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ | | 99 | | ns |
| Body Diode Reverse Recovery Charge | Q_{rr} | $I_F = 20\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$ | | 318 | | nC |

Thermal Performance

| Parameter | Symbol | Typ. | Max. | Unit |
|---|-----------------|------|------|--------------------|
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 50 | 65 | $^\circ\text{C/W}$ |
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ | 0.85 | 1.0 | $^\circ\text{C/W}$ |

Notes:

1. Computed continuous current assumes the condition of $T_{J_{\text{Max}}}$ while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under $T_{J_{\text{Max}}} = 150^\circ\text{C}$.
3. This single-pulse measurement was taken under the following condition [$L = 100\mu\text{H}, V_{GS} = 10\text{V}, V_{DS} = 75\text{V}$] while its value is limited by $T_{J_{\text{Max}}} = 150^\circ\text{C}$.
4. The power dissipation P_D is based on $T_{J_{\text{Max}}} = 150^\circ\text{C}$.
5. This value is guaranteed by design hence it is not included in the production test.
6. Continuous current rating is limited by the package used.

Typical Electrical & Thermal Characteristics

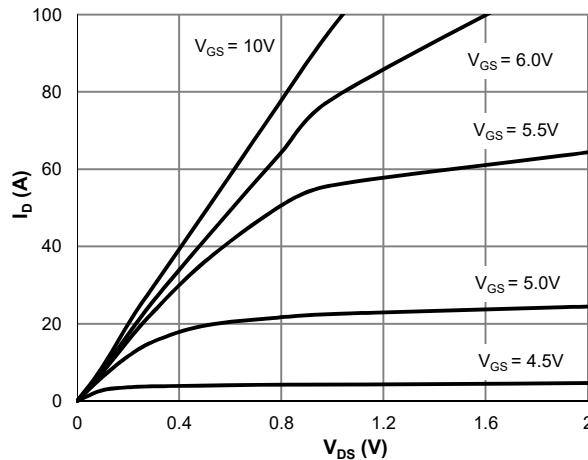


Figure 1: Saturation Characteristics

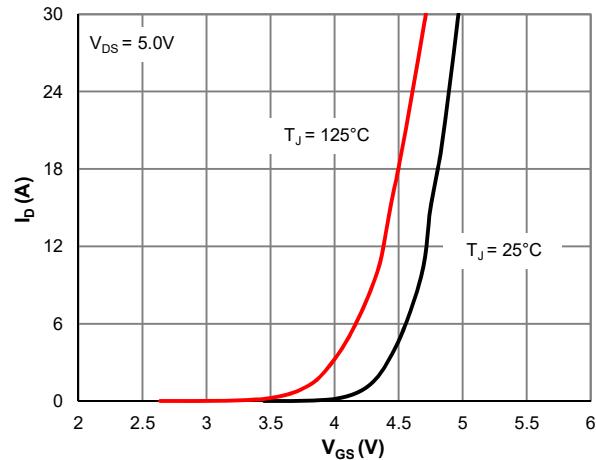


Figure 2: Transfer Characteristics

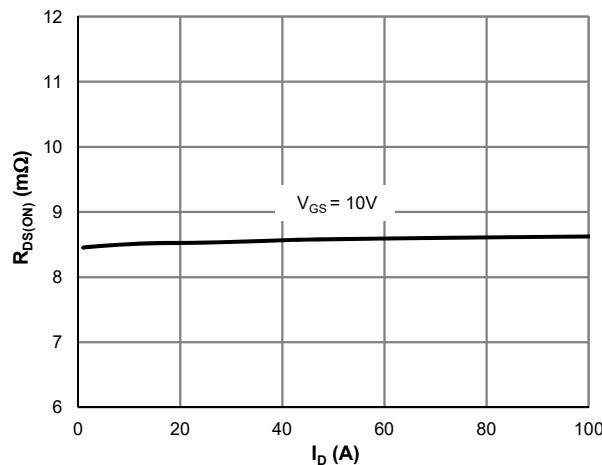


Figure 3: $R_{DS(ON)}$ vs. Drain Current

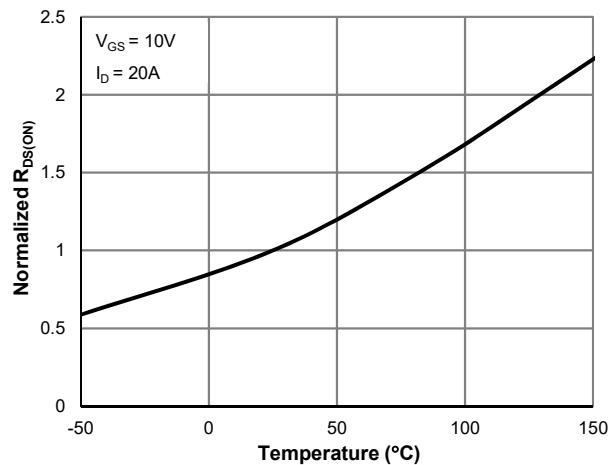


Figure 4: $R_{DS(ON)}$ vs. Junction Temperature

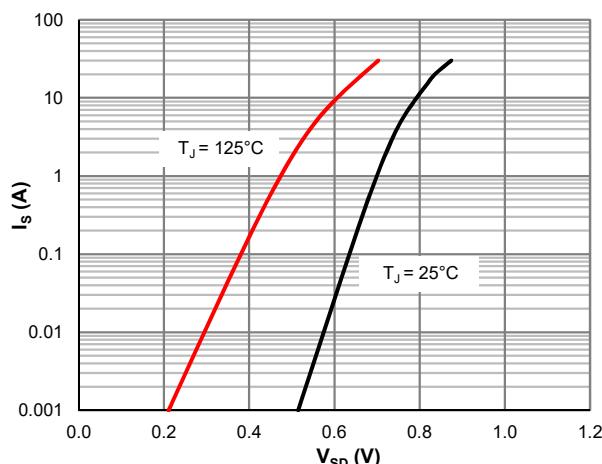


Figure 5: Body-Diode Characteristics

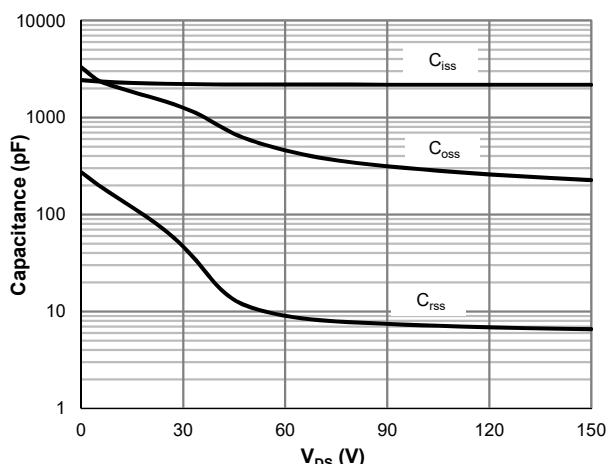


Figure 6: Capacitance Characteristics

Typical Electrical & Thermal Characteristics

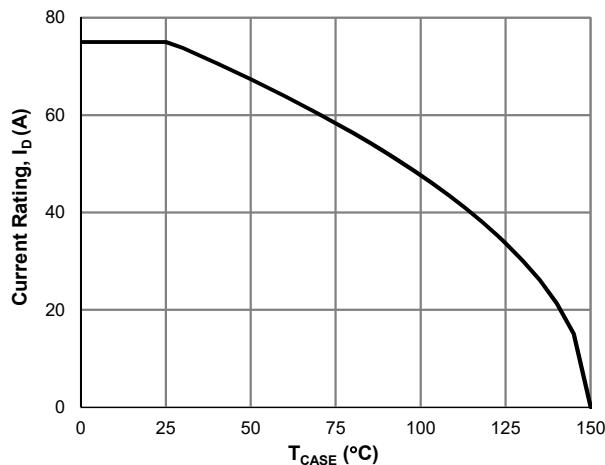


Figure 7: Current De-rating

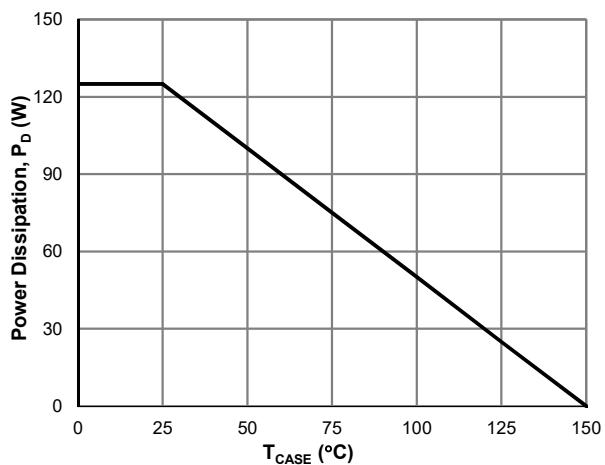


Figure 8: Power De-rating

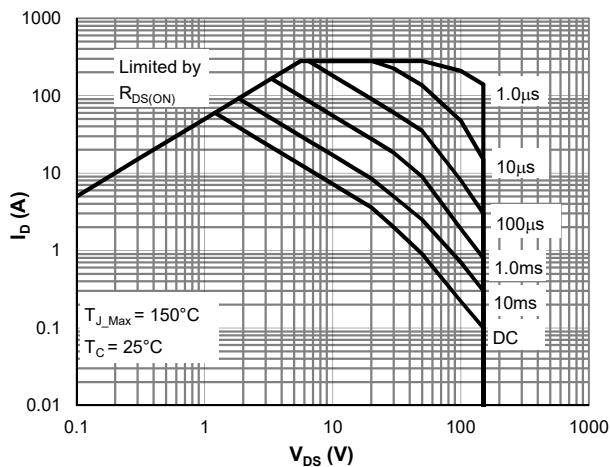


Figure 9: Maximum Safe Operating Area

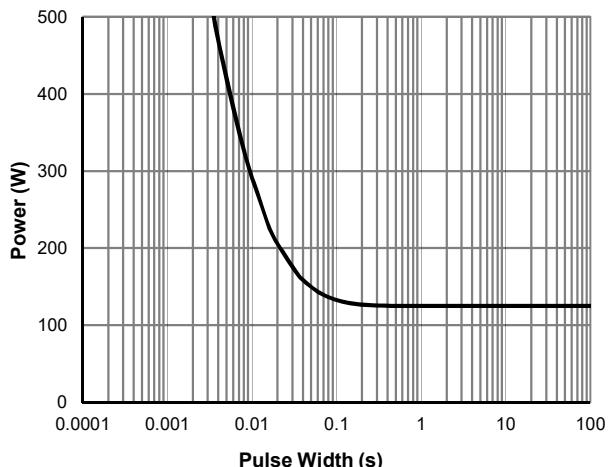


Figure 10: Single Pulse Power Rating, Junction-to-Case

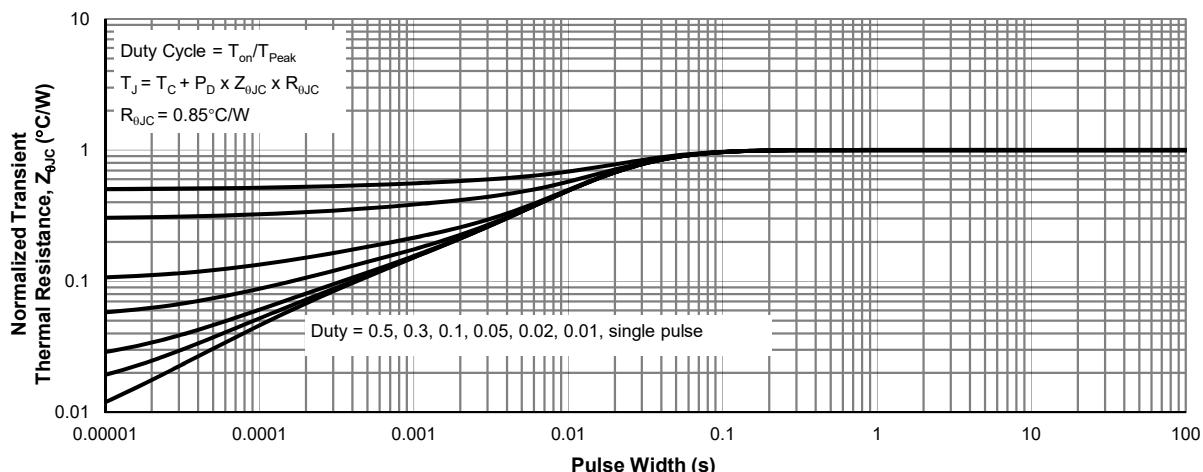
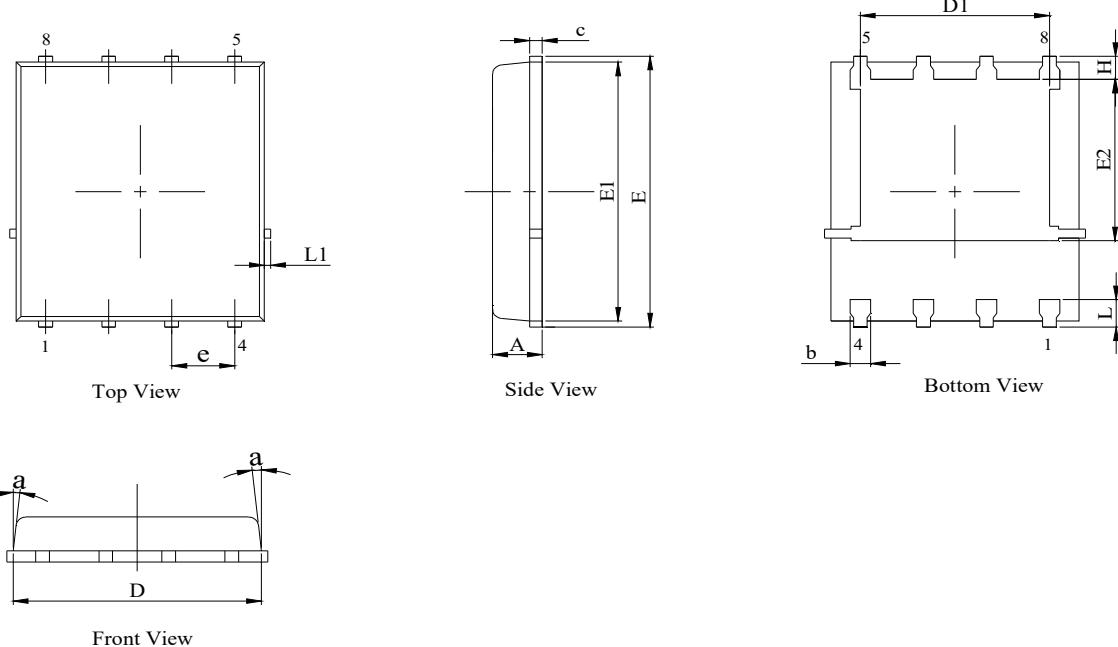
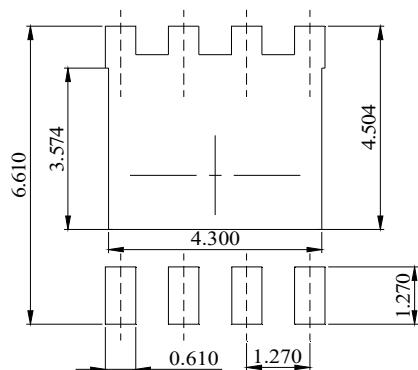


Figure 11: Normalized Maximum Transient Thermal Impedance

PDFN5x6 Package Information**Package Outline****NOTES:**

- Dimension and tolerance per ASME Y14.5M, 1994.
- All dimensions in millimeter (angle in degree).
- Dimensions D and E1 do not include mold flash protrusions or gate burrs.

| DIM. | MILLIMETER | |
|------|------------|------|
| | MIN. | MAX. |
| A | 0.90 | 1.20 |
| b | 0.33 | 0.51 |
| c | 0.23 | 0.33 |
| D | 4.80 | 5.40 |
| D1 | 3.61 | 4.25 |
| E | 5.90 | 6.30 |
| E1 | 5.55 | 5.95 |
| E2 | 3.35 | 3.95 |
| e | 1.27 BSC | |
| H | 0.41 | 0.80 |
| L | 0.51 | 0.80 |
| L1 | - | 0.15 |
| a | 0° | 12° |

Recommended Footprint

DIMENSIONS: MILLIMETERS